

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Aleksandar Damnjanovic</td> <td>03/21/2013</td> </tr> <tr> <td>Durga Prasad Malladi</td> <td>05/23/2013</td> </tr> <tr> <td>Siddhartha Mallik</td> <td>03/18/2013</td> </tr> <tr> <td>Naga Bhushan</td> <td>07/01/2013</td> </tr> <tr> <td>Yongbin Wei</td> <td>05/23/2013</td> </tr> <tr> <td>Gavin Bernard Hom</td> <td>03/18/2013</td> </tr> </tbody> </table>		Name	Execution Date	Aleksandar Damnjanovic	03/21/2013	Durga Prasad Malladi	05/23/2013	Siddhartha Mallik	03/18/2013	Naga Bhushan	07/01/2013	Yongbin Wei	05/23/2013	Gavin Bernard Hom	03/18/2013
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<table border="1"> <tr> <td>Name:</td> <td>QUALCOMM INCORPORATED</td> </tr> <tr> <td>Street Address:</td> <td>5775 MOREHOUSE DRIVE</td> </tr> <tr> <td>City:</td> <td>San Diego</td> </tr> <tr> <td>State/Country:</td> <td>CALIFORNIA</td> </tr> <tr> <td>Postal Code:</td> <td>92121</td> </tr> </table>		Name:	QUALCOMM INCORPORATED	Street Address:	5775 MOREHOUSE DRIVE	City:	San Diego	State/Country:	CALIFORNIA	Postal Code:	92121				
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PROPERTY NUMBERS Total: 1															
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13830702</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13830702										
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Application Number:	13830702														
CORRESPONDENCE DATA															
Fax Number:	3102015219														
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>															
Phone:	310.277.7200														
Email:	qualcomm-uspto@seyfarth.com														
Correspondent Name:	Seyfarth Shaw LLP														
Address Line 1:	2029 Century Park East , Suite 3500														
Address Line 4:	Los Angeles, CALIFORNIA 90067														
ATTORNEY DOCKET NUMBER:	122308														
NAME OF SUBMITTER:	Puya Partow-Navid														

CH \$40.00 13830702

Signature:	/Puya Partow-Navid/
Date:	07/16/2013
Total Attachments: 15 source=122308_Assignment_AsFiled_16July2013#page1.tif source=122308_Assignment_AsFiled_16July2013#page2.tif source=122308_Assignment_AsFiled_16July2013#page3.tif source=122308_Assignment_AsFiled_16July2013#page4.tif source=122308_Assignment_AsFiled_16July2013#page5.tif source=122308_Assignment_AsFiled_16July2013#page6.tif source=122308_Assignment_AsFiled_16July2013#page7.tif source=122308_Assignment_AsFiled_16July2013#page8.tif source=122308_Assignment_AsFiled_16July2013#page9.tif source=122308_Assignment_AsFiled_16July2013#page10.tif source=122308_Assignment_AsFiled_16July2013#page11.tif source=122308_Assignment_AsFiled_16July2013#page12.tif source=122308_Assignment_AsFiled_16July2013#page13.tif source=122308_Assignment_AsFiled_16July2013#page14.tif source=122308_Assignment_AsFiled_16July2013#page15.tif	

ASSIGNMENT

WHEREAS, WE,

1. **Aleksandar Damnjanovic**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121, and a resident of Del Mar, CA,
2. **Durga Prasad Malladi**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121, and a resident of San Diego, CA,
3. **Siddhartha Mallik**, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121, and a resident of San Diego, CA,
4. **Naga Bhushan**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121, and a resident of San Diego, CA,
5. **Yongbin Wei**, a citizen of the China, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121, and a resident of San Diego, CA,
6. **Gavin Bernard Horn**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121, and a resident of La Jolla, CA,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **SMALL CELL ACTIVATION PROCEDURE** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 13/830,702 filed March 14, 2013, Qualcomm Reference No. 122308, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 61/635,288, filed April 18, 2012, Qualcomm Reference No. 122308P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add

herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

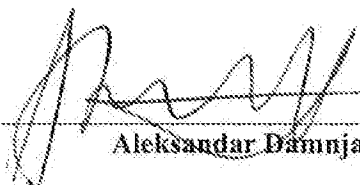
AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at San Diego, CA, on 3/21/13
LOCATION DATE


Aleksandar Damnjanovic

Done at _____, on _____
LOCATION DATE

Durga Prasad Malladi

Done at _____, on _____
LOCATION DATE

Siddhartha Mallik

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Yongbin Wei

Done at _____, on _____
LOCATION DATE

Gavin Bernard Horn

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AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
LOCATION DATE Aleksandar Damnjanovic

Done at San Diego, on 5/23/13
LOCATION DATE Durga Prasad Malladi

Done at _____, on _____
LOCATION DATE Siddhartha Mallik

Done at _____, on _____
LOCATION DATE Naga Bhushan

Done at San Diego, on 5-23-13
LOCATION DATE Yongbin Wei

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Done at _____, on _____
LOCATION DATE Aleksandar Damjanovic

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LOCATION DATE Durga Prasad Malladi

Done at San Diego, on 03/18/2013
LOCATION DATE Siddhartha Mallik

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Done at _____, on _____
LOCATION DATE Aleksandar Damjanovic

Done at _____, on _____
LOCATION DATE Durga Prasad Malladi

Done at _____, on _____
LOCATION DATE Siddhartha Mallik

Done at San Diego, on 07/01/2013
LOCATION DATE 
Naga Bhushan

Done at _____, on _____
LOCATION DATE Yongbin Wei

Done at _____, on _____
LOCATION DATE Gavin Bernard Horn

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have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **SMALL CELL ACTIVATION PROCEDURE** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). **13/830,702** filed **March 14, 2013**, Qualcomm Reference No. **122308**, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). **61/635,288**, filed **April 18, 2012**, Qualcomm Reference No. **122308P1**, (and do hereby authorize ASSIGNEE and its representative to hereafter add

herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

